

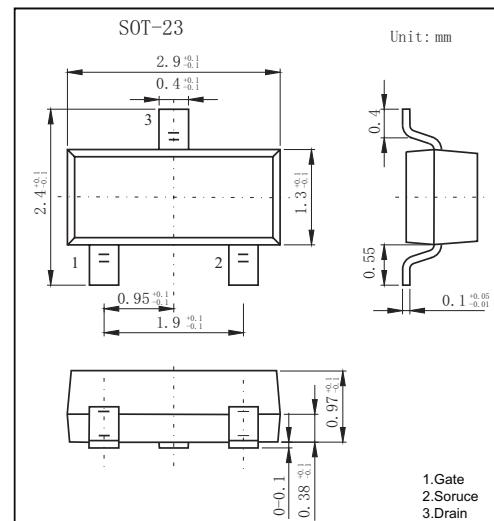
## SOT-23 Plastic-Encapsulate MOSFETS

### FEATURE

- TrenchFET Power MOSFET
- P-Channel 30-V(D-S) MOSFET

### MECHANICAL DATA

- Case style:SOT-23molded plastic
- Mounting position:any



### MAXIMUM RATINGS AND CHARACTERISTICS

@ 25°C Ambient Temperature (unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DS</sub>	-30	V
Gate-Source Voltage	V <sub>GS</sub>	±20	
Continuous Drain Current	I <sub>D</sub>	-1.9	A
Continuous Source-Drain Diode Current	I <sub>S</sub>	-0.83	
Maximum Power Dissipation	P <sub>D</sub>	0.35	W
Thermal Resistance from Junction to Ambient(t≤5s)	R <sub>θJA</sub>	357	°C/W
Junction Temperature	T <sub>J</sub>	150	°C
Storage Temperature	T <sub>STG</sub>	-50 ~+150	

## RATINGS AND CHARACTERISTIC CURVES

**MOSFET ELECTRICAL CHARACTERISTICS** Ta=25 °C unless otherwise specified

Parameter	Symbol	Test Condition	Min	Typ	Max	Units	
<b>Static</b>							
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA	-30			V	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA	-1	-1.6	-3		
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±20V			±100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = -30V, V <sub>GS</sub> = 0V			-1	μA	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = -10V, I <sub>D</sub> = -1.9A		0.075	0.190	Ω	
		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -1.4A		0.115	0.330		
Forward Transconductance <sup>a</sup>	g <sub>f</sub>	V <sub>DS</sub> = -5V, I <sub>D</sub> = -1.9A	1			S	
<b>Dynamic<sup>b</sup></b>							
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = -15V, V <sub>GS</sub> = 0V, f = 1MHz		155		pF	
Output Capacitance	C <sub>oss</sub>			35			
Reverse Transfer Capacitance	C <sub>rss</sub>			25			
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> = -15V, V <sub>GS</sub> = -10V, I <sub>D</sub> = -1.9A		4	8	nC	
Gate-Source Charge	Q <sub>gs</sub>			2	4		
Gate-Drain Charge	Q <sub>gd</sub>			0.6			
Gate Resistance	R <sub>g</sub>		f = 1MHz	1.7	8.5	17	Ω
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> = -15V, R <sub>L</sub> = 10Ω, I <sub>D</sub> = -1.5A, V <sub>GEN</sub> = -10V, R <sub>g</sub> = 1Ω			4	8	ns
Rise Time	t <sub>r</sub>				11	18	
Turn-Off Delay Time	t <sub>d(off)</sub>				11	18	
Fall Time	t <sub>f</sub>				8	16	
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> = -15V, R <sub>L</sub> = 10Ω, I <sub>D</sub> = -1.5A, V <sub>GEN</sub> = -4.5V, R <sub>g</sub> = 1Ω			36	44	
Rise Time	t <sub>r</sub>				37	45	
Turn-Off Delay Time	t <sub>d(off)</sub>				12	18	
Fall Time	t <sub>f</sub>				9	14	
<b>Drain-source Body diode characteristics</b>							
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25°C			-1.75	A	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				-10		
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = -1.5A		-0.8	-1.2	V	

**Notes :**

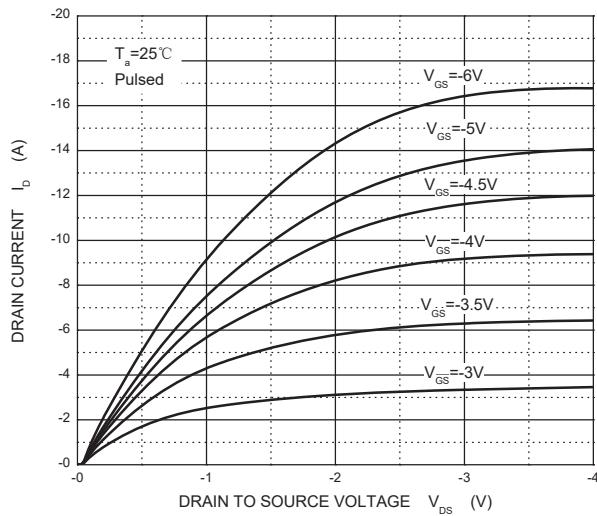
a. Pulse Test : Pulse Width ≤300μs, Duty Cycle ≤2%.

b. Guaranteed by design, not subject to production testing.

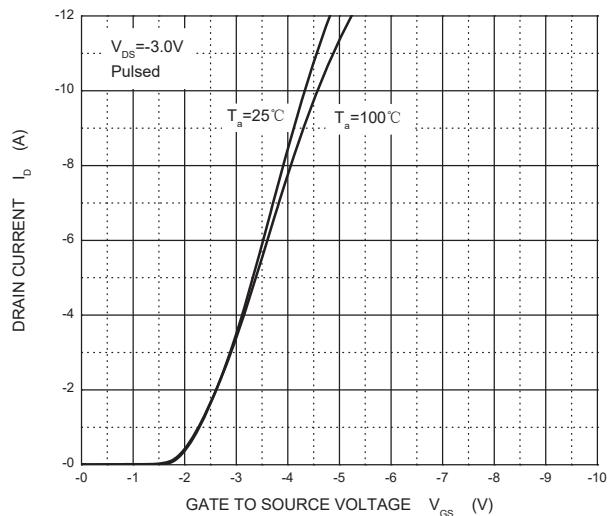
## RATINGS AND CHARACTERISTIC CURVES

### Typical Characteristics

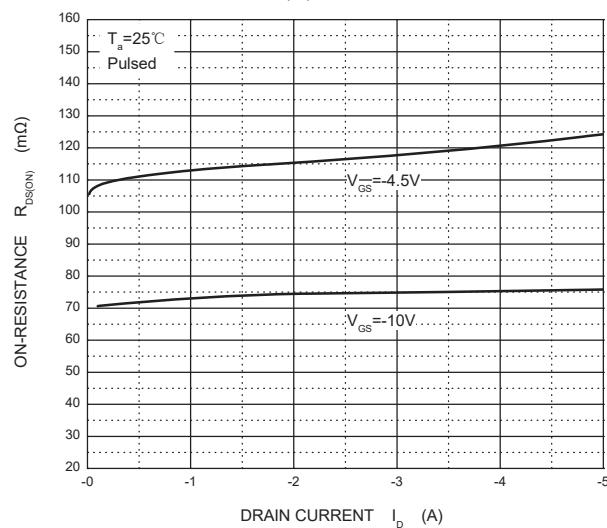
**Output Characteristics**



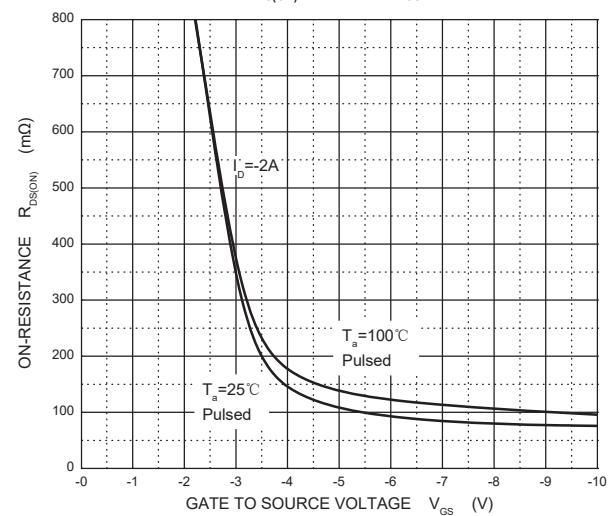
**Transfer Characteristics**



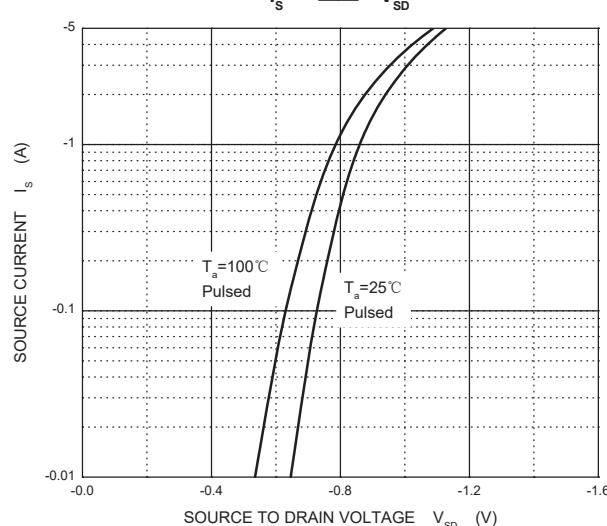
$R_{DS(ON)}$  —  $I_D$



$R_{DS(ON)}$  —  $V_{GS}$



$I_s$  —  $V_{SD}$



**Threshold Voltage**

